

Phase Control Thyristor

Types N0131SH120 to N0131SH160

Absolute Maximum Ratings

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
V _{DRM}	Repetitive peak off-state voltage, (note 1)	1200-1600	V
V _{DSM}	Non-repetitive peak off-state voltage, (note 1)	1200-1600	V
V _{RRM}	Repetitive peak reverse voltage, (note 1)	1200-1600	V
V _{RSM}	Non-repetitive peak reverse voltage, (note 1)	1300-1600	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
I _{T(AV)}	Mean on-state current, T _{sink} =55°C, (note 2)	131	A
I _{T(AV)}	Mean on-state current. T _{sink} =85°C, (note 2)	85	A
I _{T(RMS)}	Nominal RMS on-state current, T _{sink} =25°C, (note 2)	269	A
I _{T(d.c.)}	D.C. on-state current, T _{sink} =25°C, (note 4)	212	A
I _{TSM}	Peak non-repetitive surge t _p =10ms, V _{RM} =0.6V _{RRM} , (note 5)	1700	A
I _{TSM2}	Peak non-repetitive surge t _p =10ms, V _{RM} ≤10V, (note 5)	1950	A
I ² t	I ² t capacity for fusing t _p =10ms, V _{RM} =0.6V _{RRM} , (note 5)	14.5×10 ³	A ² s
I ² t	I ² t capacity for fusing t _p =10ms, V _{RM} ≤10V, (note 5)	19×10 ³	A ² s
(di/dt) _{cr}	Maximum rate of rise of on-state current (repetitive), (Note 6)	500	A/μs
	Maximum rate of rise of on-state current (non-repetitive), (Note 6)	1000	A/μs
V _{FGM}	Peak forward gate voltage	18	V
V _{RGM}	Peak reverse gate voltage	5	V
P _{G(AV)}	Mean forward gate power	2	W
P _{GM}	Peak forward gate power	100	W
V _{GD}	Non-trigger gate voltage, (Note 7)	0.25	V
T _{HS}	Operating temperature range	-40 to +125	°C
T _{stg}	Storage temperature range	-40 to +150	°C

Notes:-

- 1) De-rating factor of 0.13% per °C is applicable for T_j below 25°C.
- 2) Double side cooled, single phase; 50Hz, 180° half-sinewave.
- 3) Single side cooled, single phase; 50Hz, 180° half-sinewave.
- 4) Double side cooled.
- 5) Half-sinewave, 125°C T_j initial.
- 6) V_D=67% V_{DRM}, I_{FG}=2A, t_r≤0.5μs, T_{case}=125°C.
- 7) Rated V_{DRM}.

Characteristics

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS (Note 1)	UNITS
V_{TM}	Maximum peak on-state voltage	-	-	2.19	$I_{TM}=270A$	V
V_{TO}	Threshold voltage	-	-	1.57		V
r_T	Slope resistance	-	-	2.29		m Ω
$(dv/dt)_{cr}$	Critical rate of rise of off-state voltage	200	-	-	$V_D=80\% V_{DRM}$	V/ μ s
I_{DRM}	Peak off-state current	-	-	20	Rated V_{DRM}	mA
I_{RRM}	Peak reverse current	-	-	20	Rated V_{RRM}	mA
V_{GT}	Gate trigger voltage	-	-	3.0	$T_j=25^\circ C$	V
I_{GT}	Gate trigger current	-	-	150	$T_j=25^\circ C$ $V_D=10V, I_T=3A$	mA
I_H	Holding current	-	-	600	$T_j=25^\circ C$	mA
R_{thJK}	Thermal resistance, junction to heatsink	-	-	0.23	Double side cooled	K/W
F	Mounting torque	-	-	14		kN
W_t	Weight	-	130	-		g

Notes:-

 1) Unless otherwise indicated $T_j=125^\circ C$.

Notes on Ratings and Characteristics

1.0 Voltage Grade Table

Voltage Grade	V_{DRM} V_{DSM} V_{RRM} V	V_{RSM} V	V_D V_R DC V
12	1200	1300	810
16	1600	1700	1040

2.0 Extension of Voltage Grades

This report is applicable to other and higher voltage grades when supply has been agreed by Sales/Production.

3.0 Extension of Turn-off Time

This Report is applicable to other t_q /re-applied dv/dt combinations when supply has been agreed by Sales/Production.

4.0 Repetitive dv/dt

Higher dv/dt selections are available up to 1000V/ μ s on request.

5.0 De-rating Factor

A blocking voltage de-rating factor of 0.13%/°C is applicable to this device for T_j below 25°C.

6.0 Rate of rise of on-state current

The maximum un-primed rate of rise of on-state current must not exceed 1500A/ μ s at any time during turn-on on a non-repetitive basis. For repetitive performance, the on-state rate of rise of current must not exceed 1000A/ μ s at any time during turn-on. Note that these values of rate of rise of current apply to the total device current including that from any local snubber network.

7.0 Square wave ratings

These ratings are given for load component rate of rise of forward current of 100 and 500 A/ μ s.

8.0 Duty cycle lines

The 100% duty cycle is represented on all the ratings by a straight line. Other duties can be included as parallel to the first.

9.0 Maximum Operating Frequency

The maximum operating frequency is set by the on-state duty, the time required for the thyristor to turn off (t_q) and for the off-state voltage to reach full value (t_v), i.e.

$$f_{\max} = \frac{1}{t_{\text{pulse}} + t_q + t_v}$$

10.0 On-State Energy per Pulse Characteristics

These curves enable rapid estimation of device dissipation to be obtained for conditions not covered by the frequency ratings.

Let E_p be the Energy per pulse for a given current and pulse width, in joules
Let $R_{th(J-Hs)}$ be the steady-state d.c. thermal resistance (junction to sink)
and T_{SINK} be the heat sink temperature.

Then the average dissipation will be:

$$W_{AV} = E_P \cdot f \text{ and } T_{SINK(max.)} = 125 - (W_{AV} \cdot R_{th(J-Hs)})$$

11.0 Reverse Recovery Loss

11.1 Determination by Measurement

From waveforms of recovery current obtained from a high frequency shunt (see Note 1, Page 5) and reverse voltage present during recovery, an instantaneous reverse recovery loss waveform must be constructed. Let the area under this waveform be E joules per pulse. A new heat sink temperature can then be evaluated from:

$$T_{SINK(new)} = T_{SINK(original)} - E \cdot (k + f \cdot R_{th(J-Hs)})$$

where $k = 0.227$ ($^{\circ}C/W$)/s

E = Area under reverse loss waveform per pulse in joules (W.s.)

f = rated frequency Hz at the original heat sink temperature.

$R_{th(J-Hs)}$ = d.c. thermal resistance ($^{\circ}C/W$).

The total dissipation is now given by:

$$W_{(TOT)} = W_{(original)} + E \cdot f$$

11.2 Determination without Measurement

In circumstances where it is not possible to measure voltage and current conditions, or for design purposes, the additional losses E in joules may be estimated as follows.

Let E be the value of energy per reverse cycle in joules (curves in Figure 9).

Let f be the operating frequency in Hz

$$T_{SINK(new)} = T_{SINK(original)} - (E \cdot R_{th} \cdot f)$$

Where $T_{SINK(new)}$ is the required maximum heat sink temperature and
 $T_{SINK(original)}$ is the heat sink temperature given with the frequency ratings.

A suitable R-C snubber network is connected across the thyristor to restrict the transient reverse voltage to a peak value (V_{rm}) of 67% of the maximum grade. If a different grade is being used or V_{rm} is other than 67% of Grade, the reverse loss may be approximated by a pro rata adjustment of the maximum value obtained from the curves.

11.3 Reverse Recovery Loss by Measurement

This thyristor has a low reverse recovered charge and peak reverse recovery current. When measuring the charge care must be taken to ensure that:

- a.c. coupled devices such as current transformers are not affected by prior passage of high amplitude forward current.
- A suitable, polarised, clipping circuit must be connected to the input of the measuring oscilloscope to avoid overloading the internal amplifiers by the relatively high amplitude forward current signal
- Measurement of reverse recovery waveform should be carried out with an appropriate critically damped snubber, connected across diode anode to cathode. The formula used for the calculation of this snubber is shown below:

$$R^2 = 4 \cdot \frac{V_r}{C_s \cdot di/dt}$$

Where: V_r = Commutating source voltage

C_s = Snubber capacitance

R = Snubber resistance

12.0 Gate Drive

The recommended pulse gate drive is 30V, 15Ω with a short-circuit current rise time of not more than 0.5μs. This gate drive must be applied when using the full di/dt capability of the device.

The duration of pulse may need to be configured with respect to the application but should be no shorter than 20μs, otherwise an increase in pulse current could be needed to supply the resulting increase in charge to trigger.

Curves

Figure 1 - On-state characteristics of Limit device

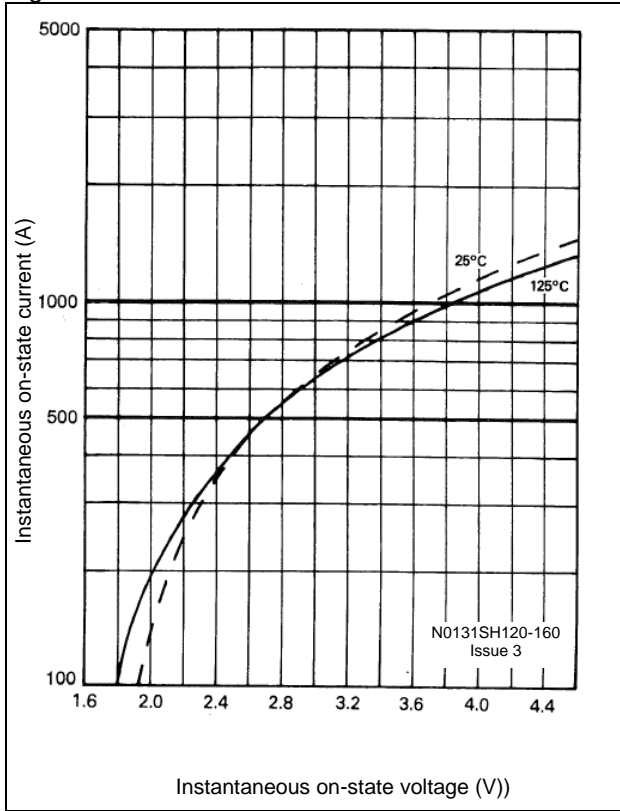


Figure 2 - Gate characteristics - Trigger limits

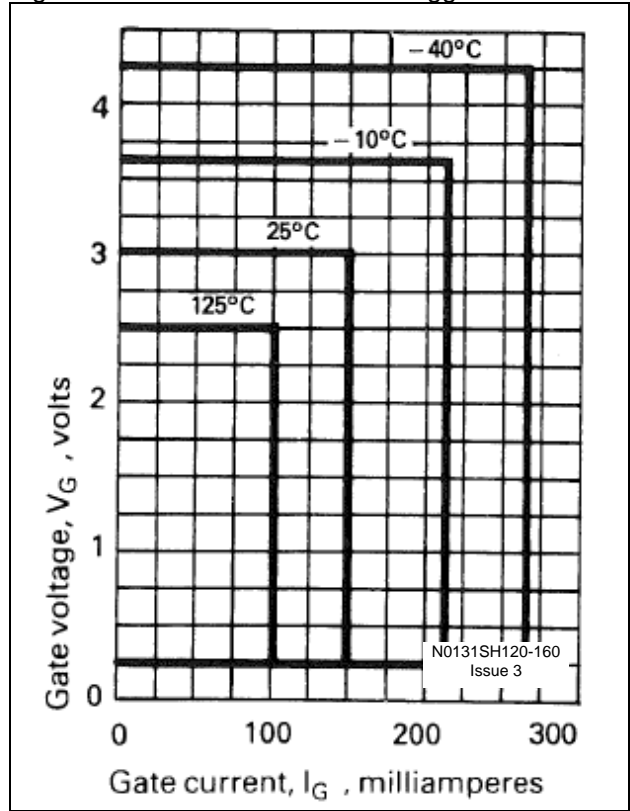


Figure 3 - Gate characteristics - Power curves

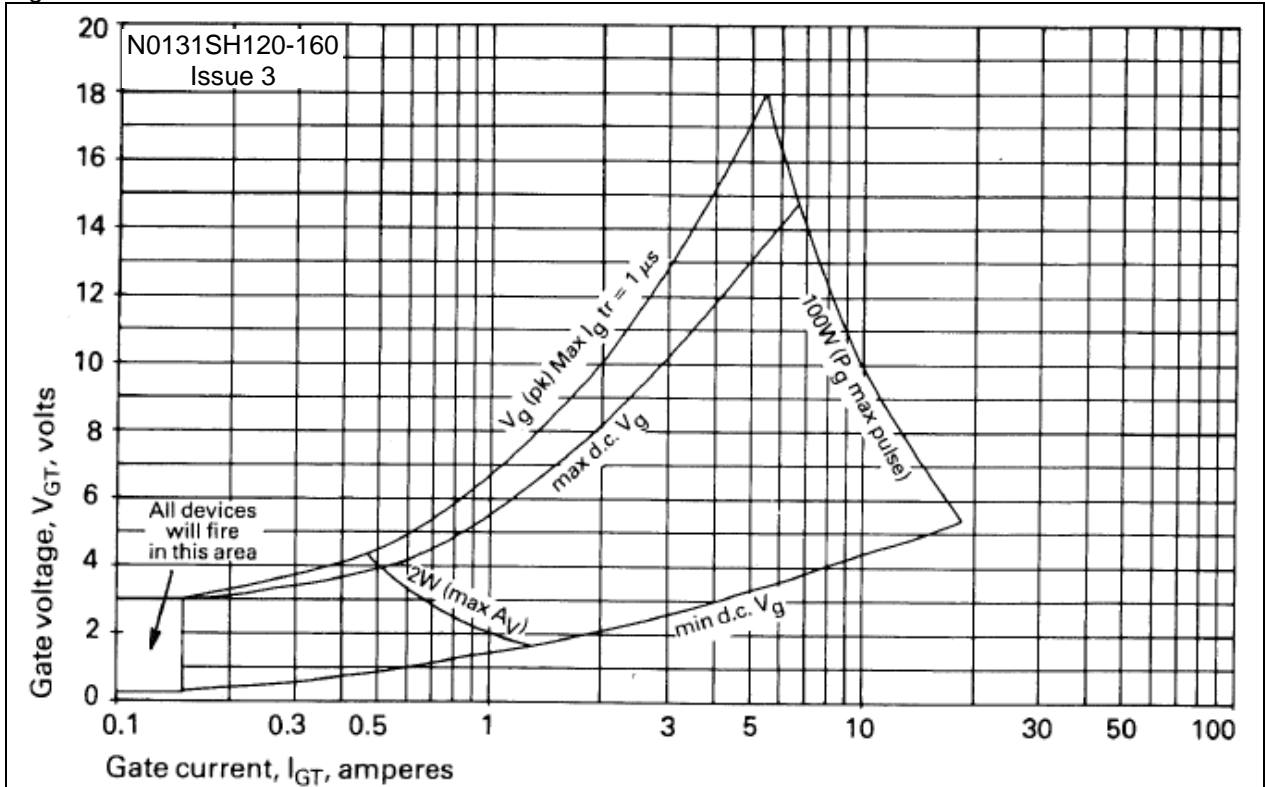
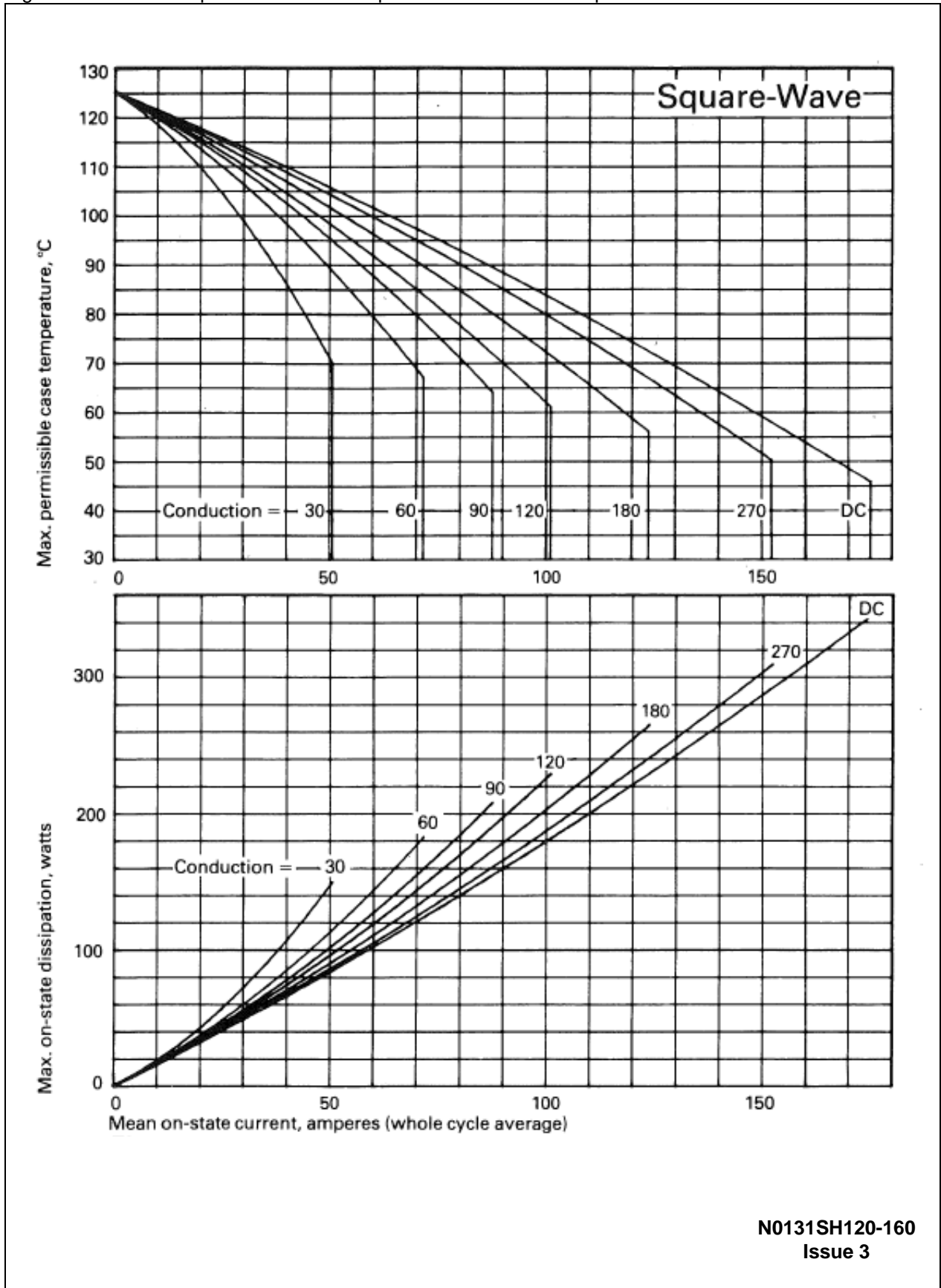


Figure 4 – Power dissipation and case temperature Vs. current – Square wave



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Figure 5 – Power dissipation and case temperature Vs. current – Sine wave

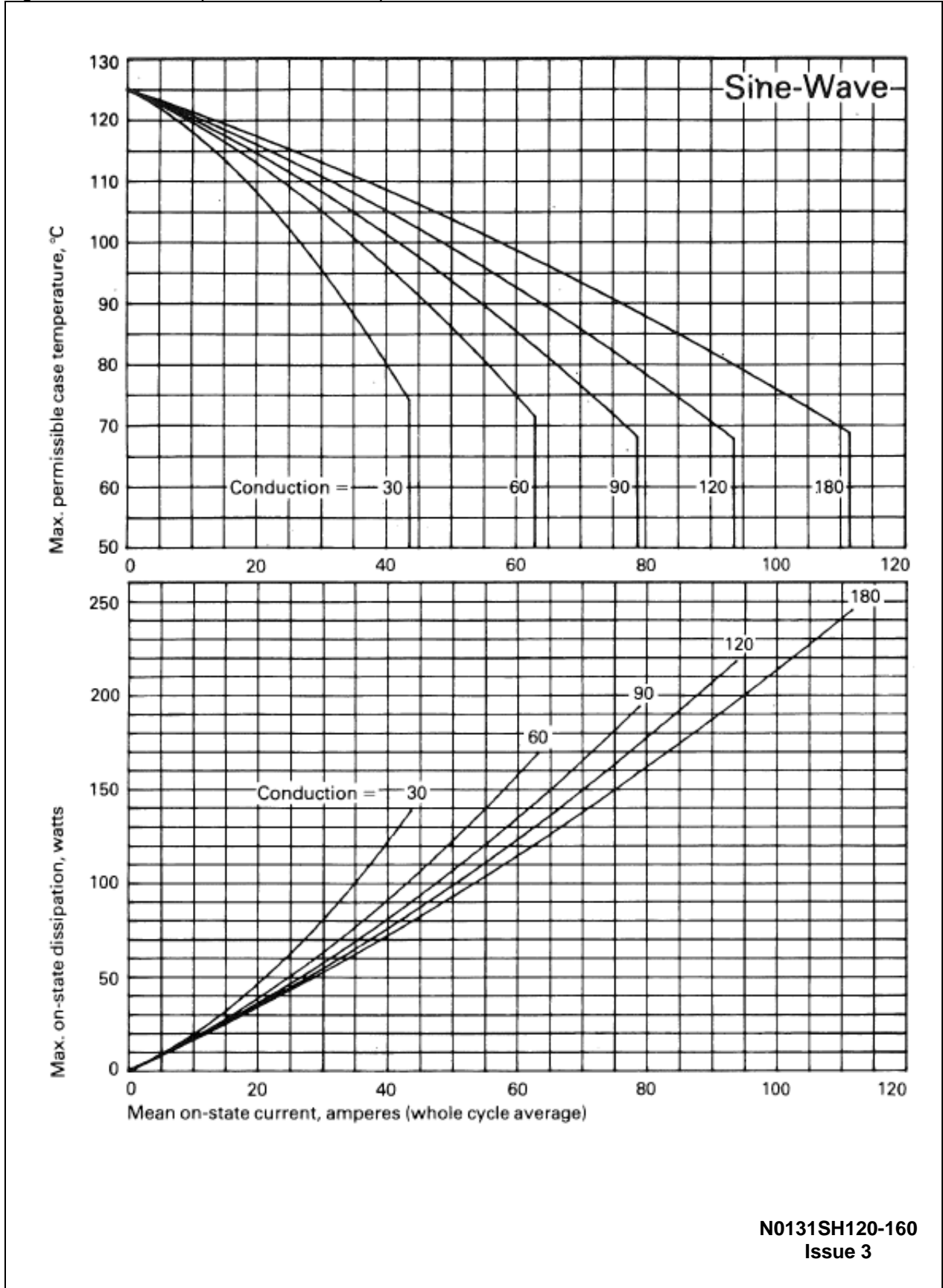


Figure 6 – thermal resistance – Junction to case

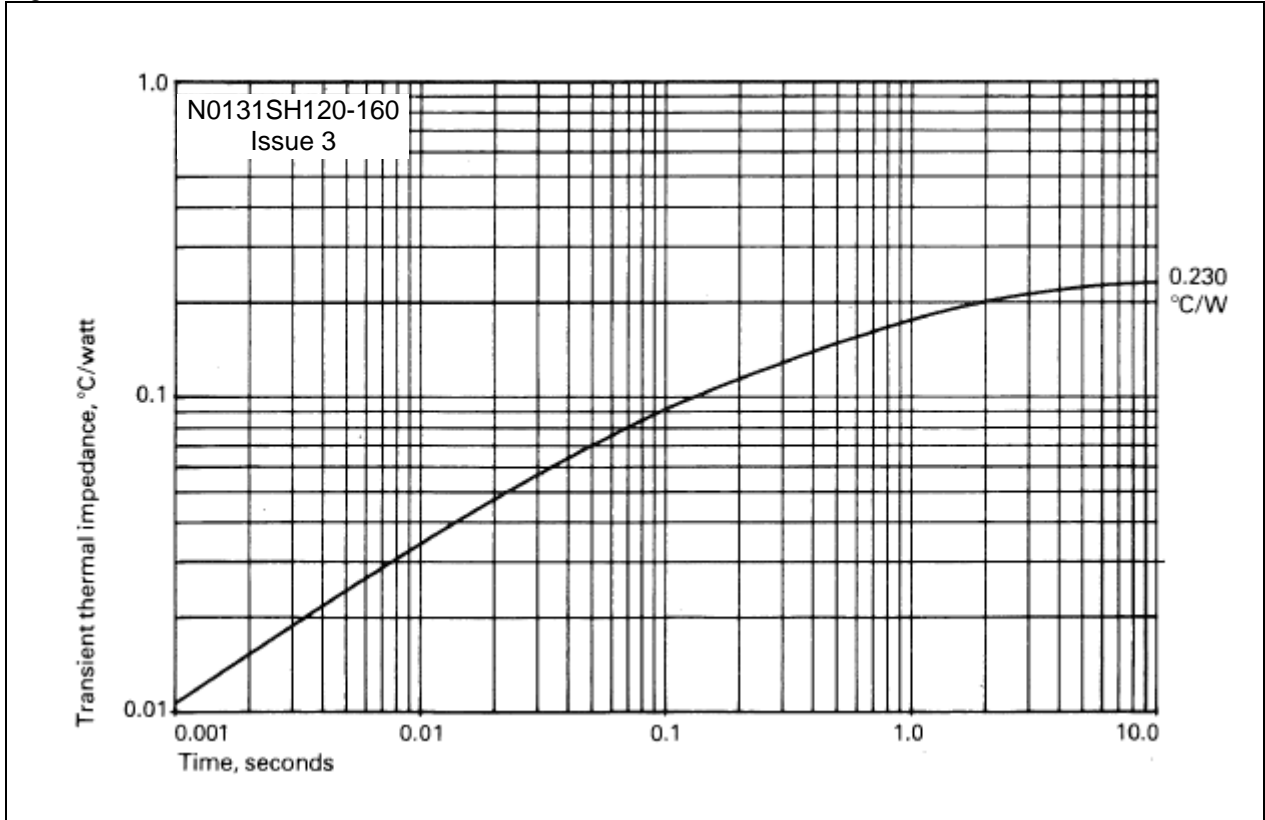
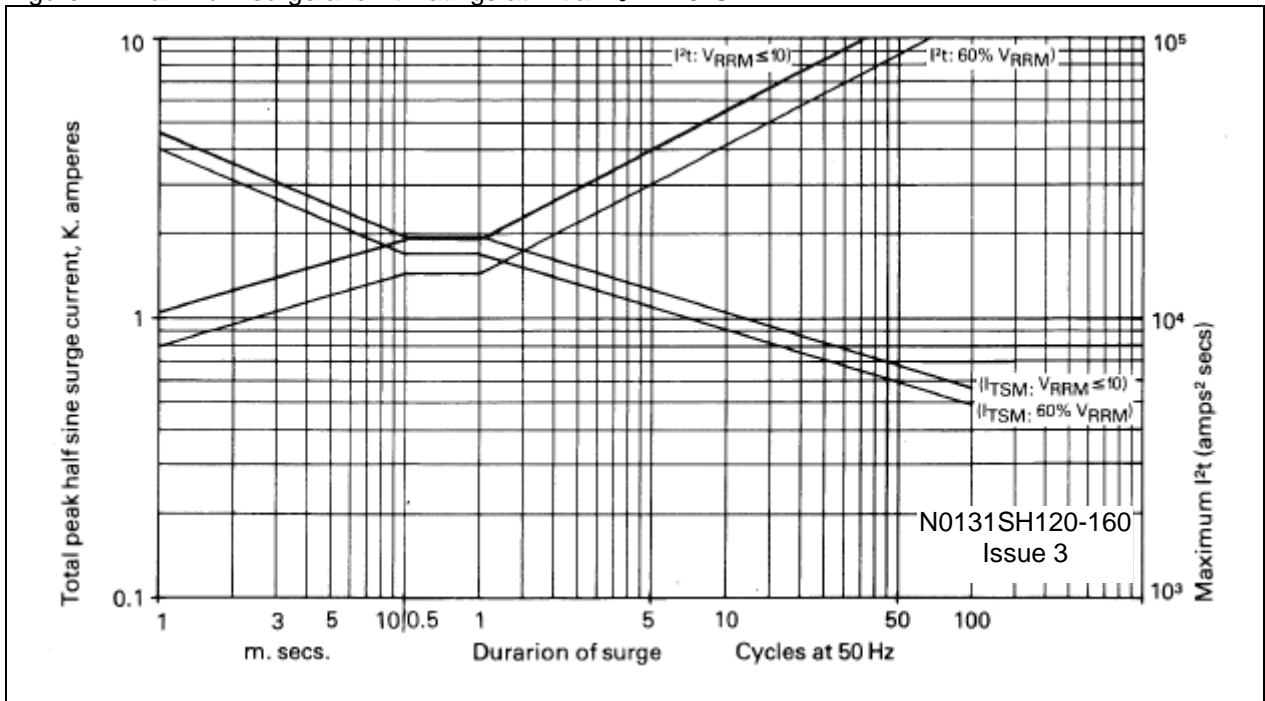
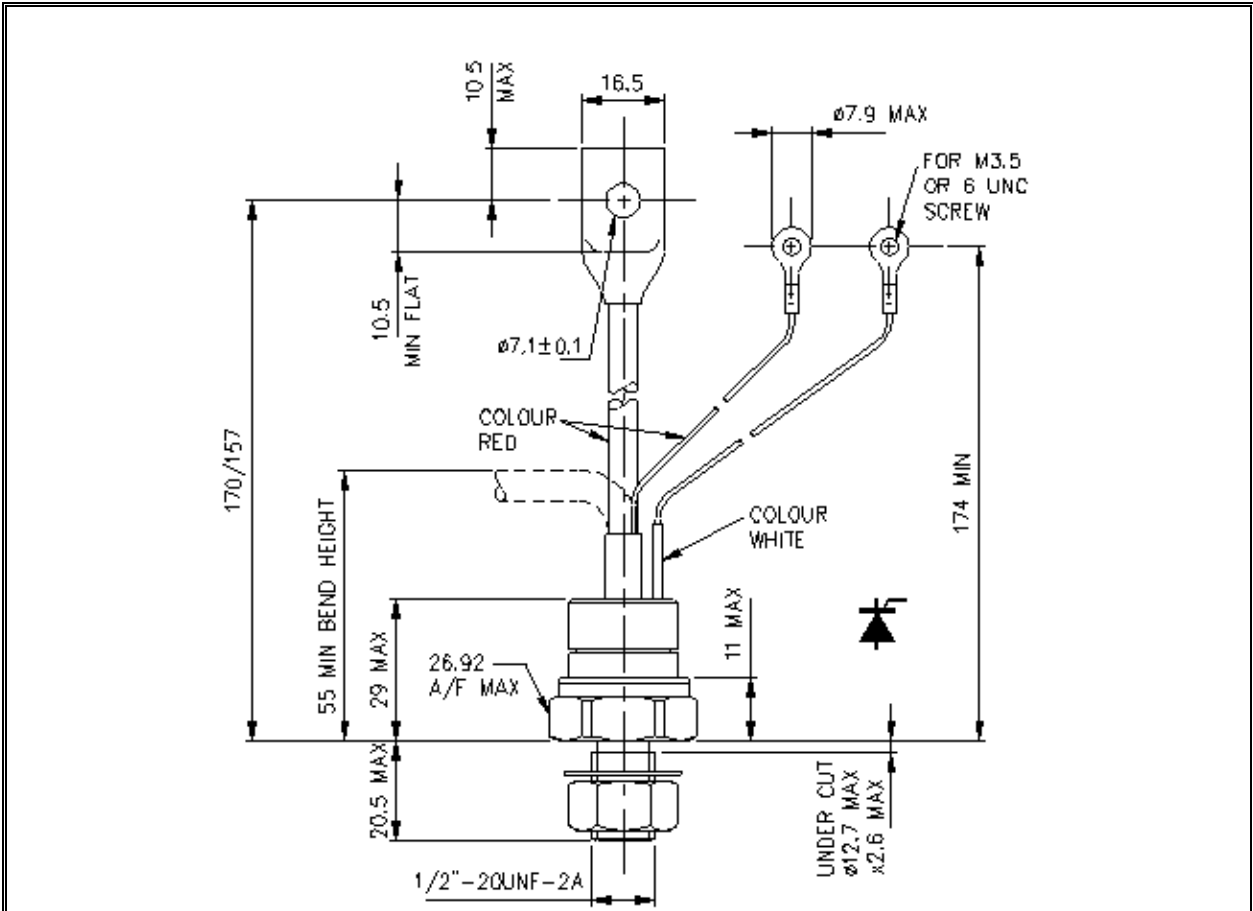


Figure 7 - Maximum surge and I²t Ratings at initial T_J – 125°C



Outline Drawing & Ordering Information



101A231

ORDERING INFORMATION

(Please quote 10 digit code as below)

N0131	SH	◆◆	0
Fixed Type Code	Fixed Outline Code	Off-state Voltage Code V _{DRM} /100 12-16	Fixed Code

Typical order code: N0131SH120 – 1200V V_{DRM}, 1/2" stud with lead

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